



NOTE:

- MATERIAL:
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY, SQ=0.40±0.03MM
- FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1um(40u") MIN Ni OVER ALL
- SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
- THE HSG. WILL WITHSTAND EXPOSURE TO 260C PEAK TEMP. FOR 10 SEC. IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.
- THE TOLERANCE OF THIS DIMENSION

4-60 PINS	± 0.20
62-100 PINS	± 0.30

6. PRODUCT NUMBERING:

20021121 - X 0 0 XX X X LF

- LEAD FREE
- PLATING:
1:GOLD FLASH ALL OVER
4:0.25um(10U")GOLD AT CONTACT
8:0.76um(30U")GOLD AT CONTACT
9:1u" GOLD OVER 30u" PdNi AT CONTACT
- PACKING
D: TUBE + CAP
T: TUBE
C: REEL+ CAP(4,6,8,10,12,16,20,22,40P)
- PIN COUNT
04,06,08,10,... 98,A0
(4 -100 EVERY EVEN PIN)
- POST OPTION
0: W/O POST
1: WITH POST

∅ 0.10	FOR 4 to 40 POS.
∅ 0.12	FOR 42 to 100 POS.

mat'l. code	surface ISO1302 ✓	tolerance ISO1101 ISO406	projection MM	product family MINITEK
l t r e c n n o d r	date	tolerances unless otherwise specified	scale 8:1	title 1.27X1.27MM BTB HEADER UNSHROUDED SMT
H BX-N-012202 ZK	07/13/12	0.X±0.38		dwg no 20021121 sheet 1 of 1 size A4
C T11-0022 ZK	04/26/11	0.XX±0.25		type Product Customer Drawing
D BX-N-010357 ZK	01/16/12	0.XXX±0.10		
E BX-N-010617 ZK	03/12/12			
F BX-N-011180 ZK	03/26/12			
G BX-N-011528 ZK	05/07/12			
sheet index	revising sheet 1			